



POWER™



PFU90R1K2G/PFD90R1K2G

N-Channel Super Junction MOSFET

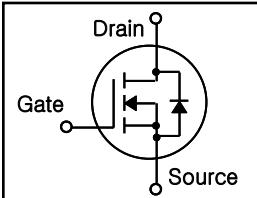
FEATURES

- New technology for high voltage device
- Low $R_{DS(on)}$ low conduction losses
- Small package
- Ultra low gate charge cause lower driving requirement
- 100% avalanche tested
- Halogen Free

BVDSS = 900 V

RDS(on) = 1.0 Ω

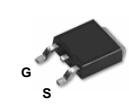
ID = 5.3 A



I-PAK(TO-251)



D-PAK(TO-252)



APPLICATION

- Power Factor Correction(PFC)
- Switched mode power supply (SMPS)
- Uninterruptible Power Supply (UPS)

Absolute Maximum Ratings

T_c=25°C unless otherwise specified

Symbol	Parameter	Value	Units
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	900	V
ID	Drain Current – Continuous (T _c = 25°C)	5.3	A
	Drain Current – Continuous (T _c = 100°C)	3.4	A
IDM(pulse)	Drain Current – Pulsed	* Note 1	A
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±30	V
EAS	Single Pulsed Avalanche Energy	* Note 2	mJ
IAR	Avalanche Current	* Note 1	A
EAR	Repetitive Avalanche Energy	* Note 1	mJ
dv/dt	Drain Source Voltage Slope, V _{DS} ≤ 480V	50	V/ns
	Reverse Diode dv/dt, V _{DS} ≤ 480V	5	V/ns
P _D	Maximum Power Dissipation (T _c = 25°C)	81	W
	Derate above 25°C	0.65	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C

* Limited by maximum junction temperature

Thermal Resistance Characteristics

Symbol	Parameter	Value	Units
R _{θJC}	Junction-to-Case (Maximum)	1.54	°C/W
R _{θJA}	Junction-to-Ambient (Maximum)	62	

Electrical Characteristics $T_A=25^\circ\text{C}$ unless otherwise specified

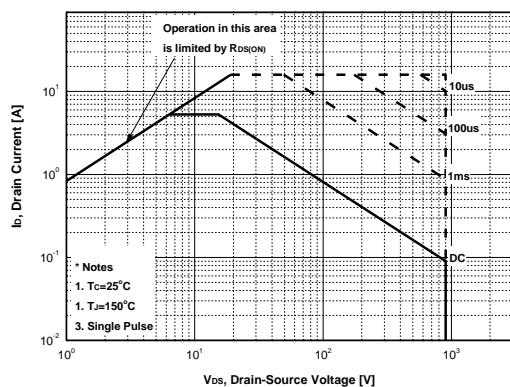
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	2.5	3.0	4.5	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$, $I_D = 2.5 \text{ A}$	--	1000	1200	m.ohm
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	900	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 900 \text{ V}$, $V_{GS} = 0 \text{ V}$	--	--	10	uA
		$V_{DS} = 720 \text{ V}$, $T_c=125^\circ\text{C}$	--	--	100	uA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	-100	nA
Dynamic Characteristics						
g_{FS}	Forward Transconductance	$V_{DS} = 20\text{V}$, $I_D = 6.0\text{A}$	--	6.0	--	S
R_G	Intrinsic Gate Resistance	$f = 1.0 \text{ MHz}$, open drain	--	2.0	--	ohm
C_{iss}	Input Capacitance	$V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$	--	680	--	pF
C_{oss}	Output Capacitance		--	55	--	pF
C_{rss}	Reverse Transfer Capacitance		--	3.5	--	pF
Q_g	Total Gate Charge	$V_{DS} = 720 \text{ V}$, $I_D = 6.0 \text{ A}$, $V_{GS} = 10 \text{ V}$	--	15.9	21	nC
Q_{gs}	Gate-Source Charge		--	3.8	--	nC
Q_{gd}	Gate-Drain Charge		--	6.1	--	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 450 \text{ V}$, $I_D = 3.0 \text{ A}$, $R_G = 15 \Omega$, $V_{GS} = 10\text{V}$	--	7	--	ns
t_r	Turn-On Rise Time		--	5	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	70	85	ns
t_f	Turn-Off Fall Time		--	9	15	ns
Source-Drain Diode Maximum Ratings and Characteristics						
I_S	Continuous Source-Drain Diode Forward Current	$I_S = 5.0 \text{ A}$, $V_{GS} = 0 \text{ V}$	--	--	5.0	A
I_{SM}	Pulsed Source-Drain Diode Forward Current		--	--	15.0	
V_{SD}	Source-Drain Diode Forward Voltage	$I_S = 5.0 \text{ A}$, $V_{GS} = 0 \text{ V}$	--	0.9	1.2	V
t_{rr}	Reverse Recovery Time	$I_S = 5.0 \text{ A}$ $dI/dt = 100 \text{ A}/\mu\text{s}$	--	260	--	ns
Q_{rr}	Reverse Recovery Charge		--	2.6	--	μC

Notes :

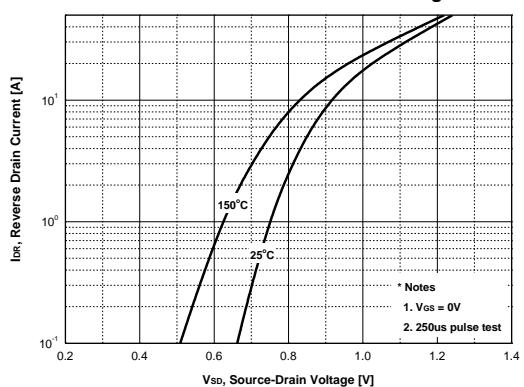
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L=22.4\text{mH}$, $I_{AS}=2.5$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$

Typical Characteristics

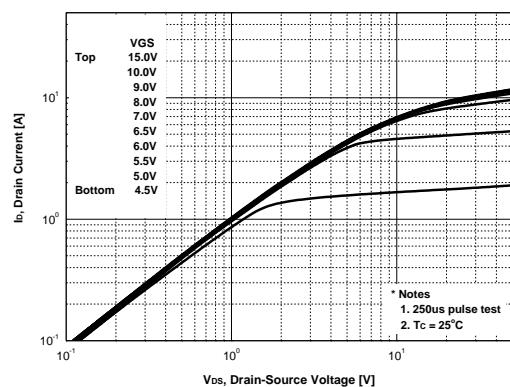
Safe Operation Area



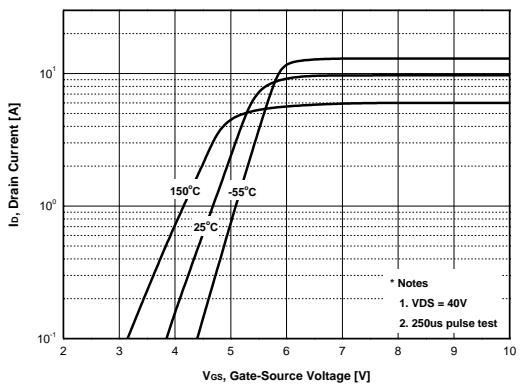
Source-Drain Diode Forward Voltage



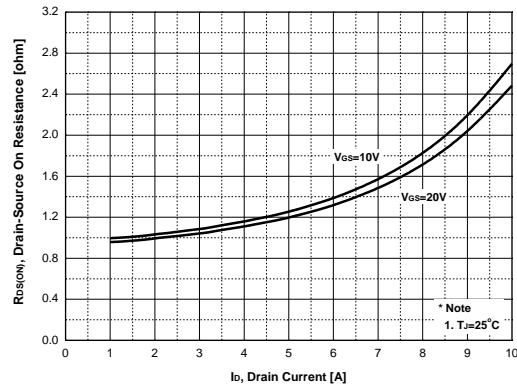
Output Characteristics



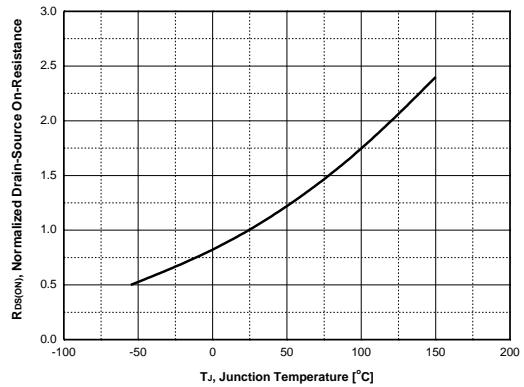
Transfer Characteristics



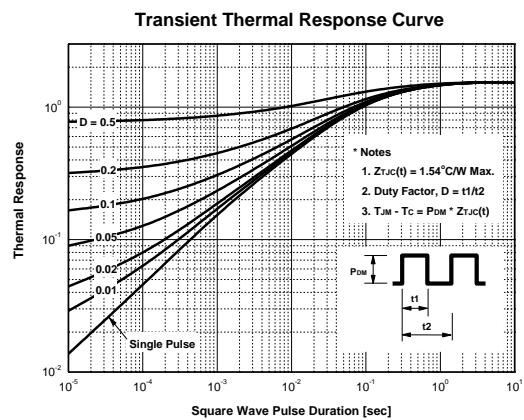
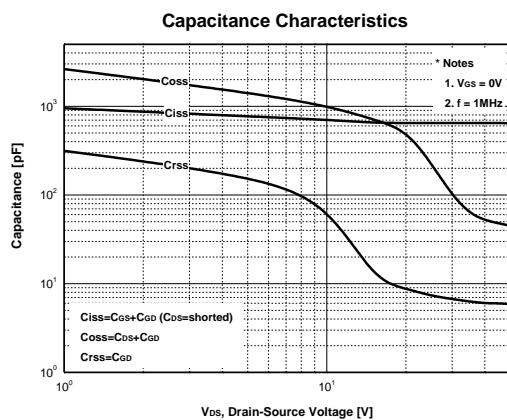
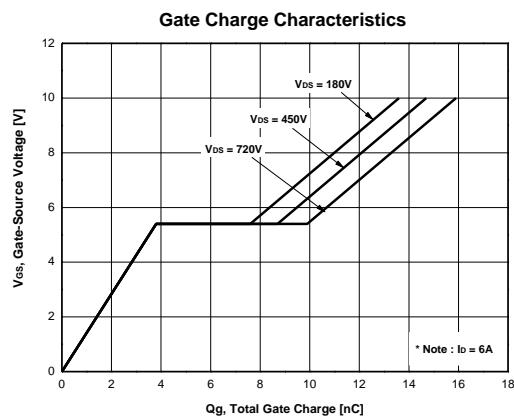
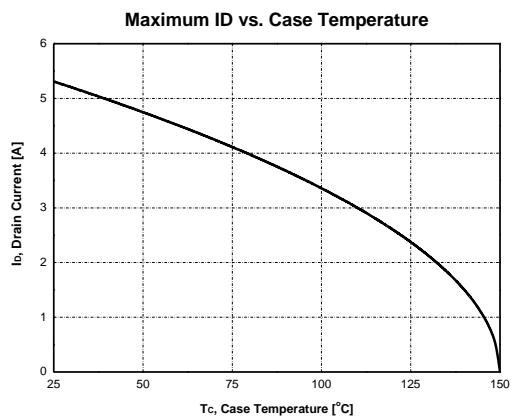
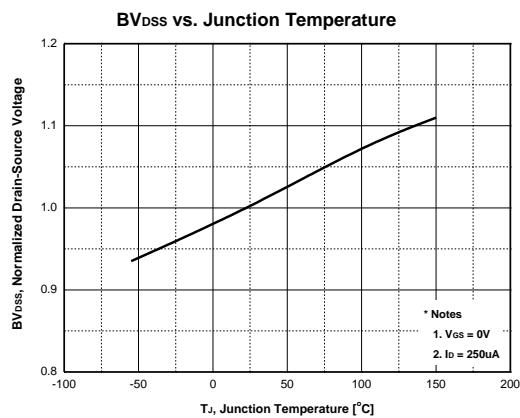
Static Drain-Source On Resistance



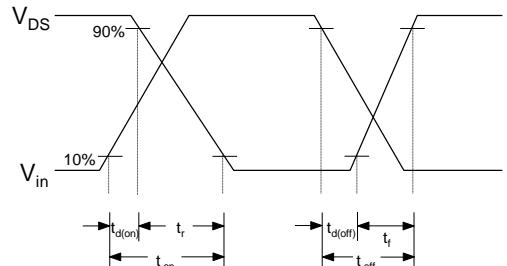
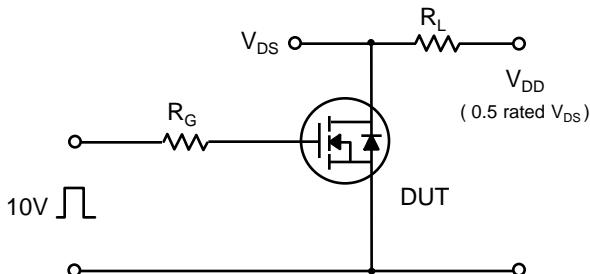
$R_{DS(ON)}$ vs. Junction Temperature



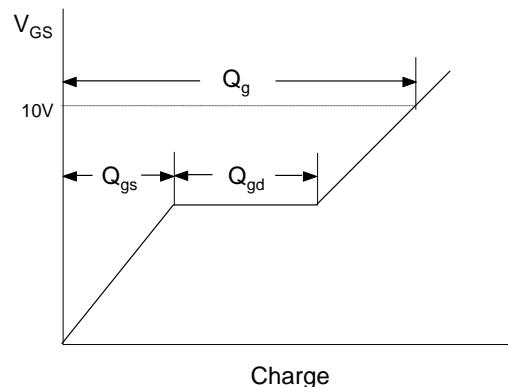
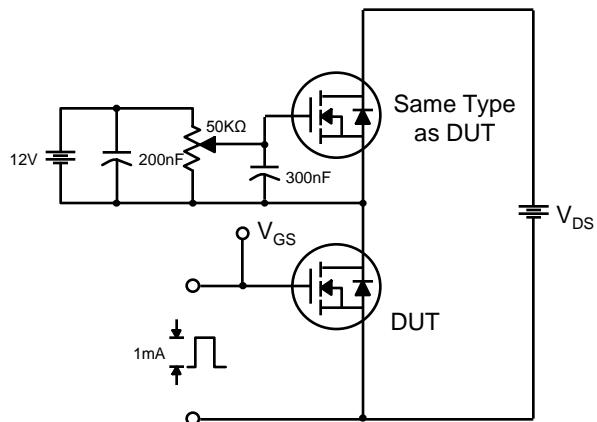
Typical Characteristics (continued)



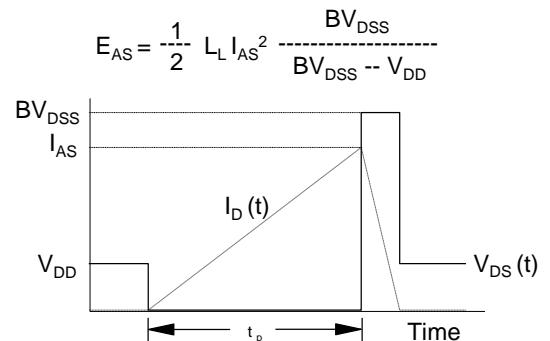
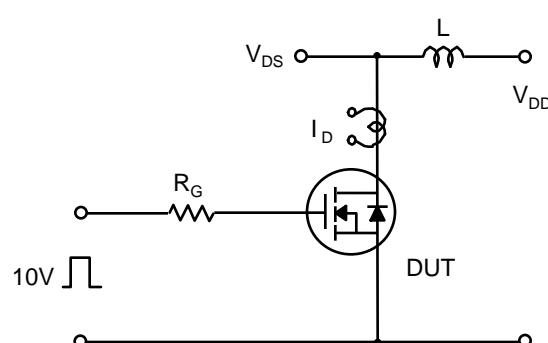
Characteristics Test Circuit & Waveform



Switching Time Test Circuit & Waveforms

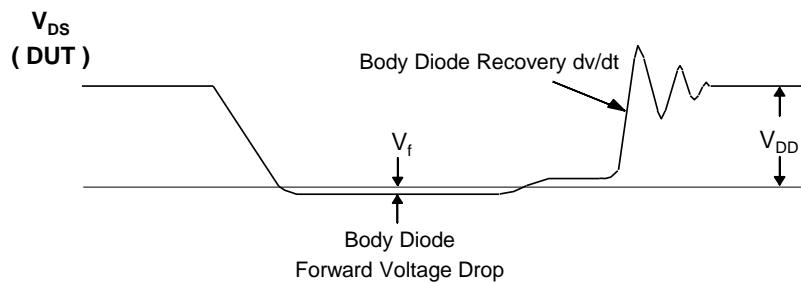
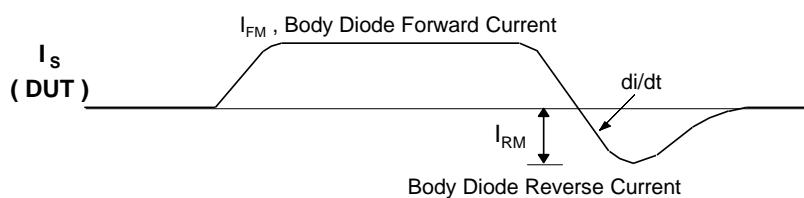
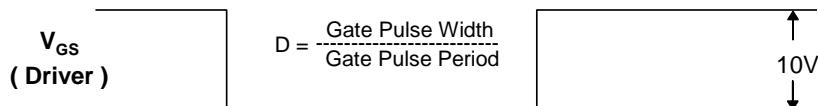
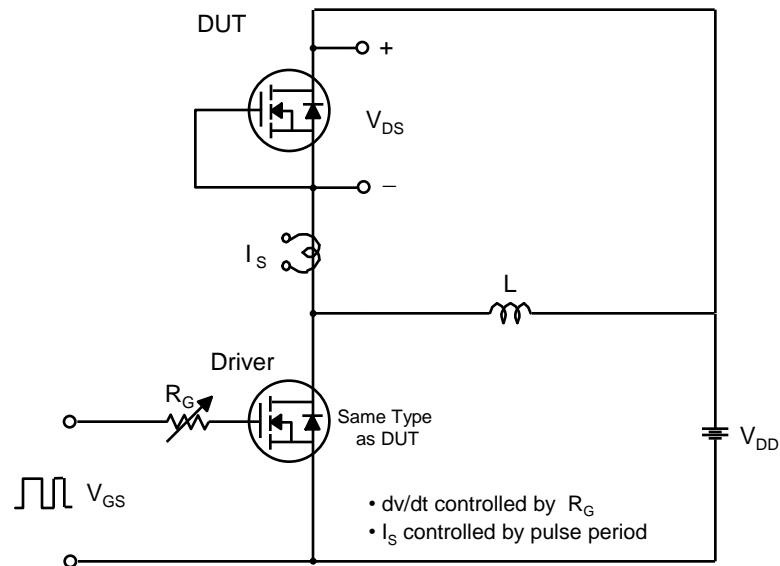


Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveforms

Characteristics Test Circuit & Waveform (continued)



Peak Diode Recovery dv/dt Test Circuit & Waveforms